

DATA SHEET

TEA1111A

Speech circuit with dialler interface,
regulated supply and earpiece
volume control

Product specification
Supersedes data of 1999 Sep 28
File under Integrated Circuits, IC03

1999 Nov 22

Speech circuit with dialler interface, regulated supply and earpiece volume control

TEA1111A

FEATURES

- Low DC line voltage; operates down to 1.5 V (excluding voltage drop across external polarity guard)
- Line voltage regulator with adjustable DC voltage
- 3.25 V regulated strong supply point for peripheral circuits compatible with:
 - Speech mode
 - Ringer mode
 - Trickle mode.
- Transmit stage with:
 - Microphone amplifier with symmetrical high impedance inputs
 - DTMF amplifier with confidence tone on earpiece.
- Receive stage with:
 - Earpiece amplifier with adjustable gain and volume control.
- $\overline{\text{MUTE}}$ input for pulse or DTMF dialling
- AGC line loss compensation for microphone and earpiece
- LED control output.

APPLICATIONS

- Line powered telephone sets with LCD module
- Cordless telephones
- Fax machines
- Answering machines.

GENERAL DESCRIPTION

The TEA1111A is a bipolar integrated circuit that performs all speech and line interface functions required in fully electronic telephone sets. It performs electronic switching between speech and dialling. The IC operates at a line voltage down to 1.5 V DC (with reduced performance) to facilitate the use of telephone sets connected in parallel.

When the line current is high enough, a fixed amount of current is derived from the LN pin in order to create a strong supply point at pin V_{DD} . The voltage at pin V_{DD} is regulated to 3.25 V to supply peripherals such as dialler, LCD module and microcontroller.

QUICK REFERENCE DATA

$I_{\text{line}} = 15 \text{ mA}$; $V_{EE} = 0 \text{ V}$; $V_{VCI} = 0 \text{ V}$; $R_{SLPE} = 20 \text{ }\Omega$; AGC pin connected to V_{EE} ; $Z_{\text{line}} = 600 \text{ }\Omega$; $f = 1 \text{ kHz}$; measured according to test circuits given in Figs 14, 15 and 16; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{line}	line current operating range	normal operation	11	–	140	mA
		with reduced performance	1	–	11	mA
V_{LN}	DC line voltage		3.7	4.0	4.3	V
I_{CC}	internal current consumption	$V_{\text{CC}} = 3.3 \text{ V}$	–	1.15	1.4	mA
V_{CC}	supply voltage for internal circuitry (unregulated)	$I_{\text{P}} = 0 \text{ mA}$	–	3.3	–	V
V_{DD}	regulated supply voltage for peripherals					
	speech mode	$I_{\text{DD}} = -3 \text{ mA}$	2.95	3.25	3.55	V
	ringer mode	$I_{\text{DD}} = 75 \text{ mA}$	3.0	3.3	3.6	V
I_{DD}	available supply current for peripherals		–	–	–3	mA
$G_{\text{V(TX)}}$	typical voltage gain for microphone amplifier	$V_{\text{MIC}} = 4 \text{ mV (RMS)}$	43.2	44.2	45.2	dB
$G_{\text{V(QR)}}$	typical voltage gain for earpiece amplifier	$V_{\text{IR}} = 4 \text{ mV (RMS)}$	26.4	27.4	28.4	dB
$\Delta G_{\text{V(QR)}}$	volume control range for earpiece amplifier		0	14.5	–	dB
$\Delta G_{\text{V(trx)}}$	gain control range for microphone and earpiece amplifiers with respect to $I_{\text{line}} = 15 \text{ mA}$	$I_{\text{line}} = 85 \text{ mA}$	–	6.0	–	dB
$\Delta G_{\text{V(trx)(m)}}$	gain reduction for microphone and earpiece amplifiers	$\overline{\text{MUTE}} = \text{LOW}$	–	80	–	dB

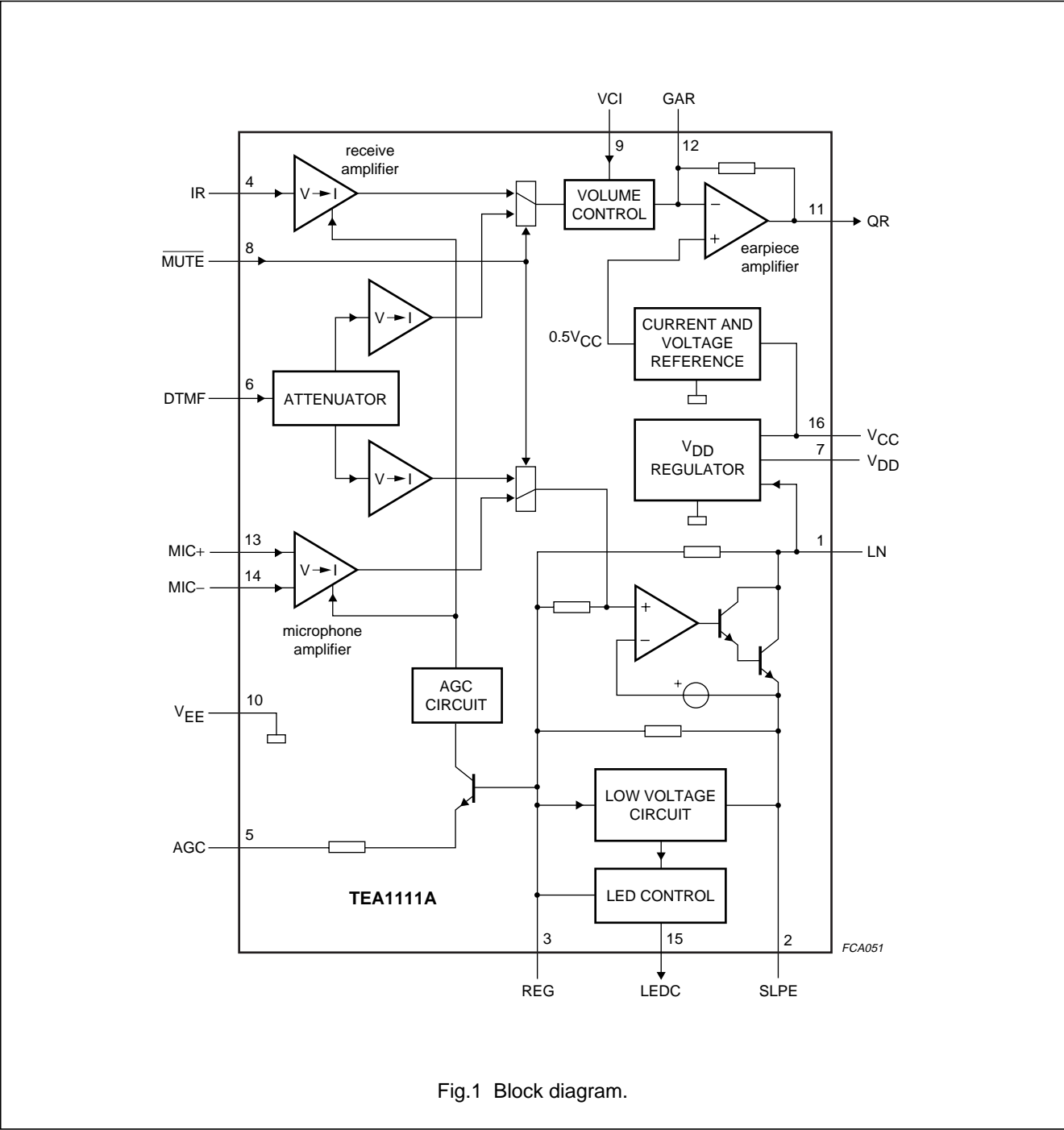
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ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
TEA1111AT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

BLOCK DIAGRAM



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PINNING

SYMBOL	PIN	DESCRIPTION
LN	1	positive line terminal
SLPE	2	slope (DC resistance) adjustment
REG	3	line voltage regulator decoupling
IR	4	receive amplifier input
AGC	5	automatic gain control/ line loss compensation
DTMF	6	dual-tone multi-frequency input
V _{DD}	7	regulated supply for peripherals
MUTE	8	mute input to select speech or dialling mode (active LOW)
VCI	9	volume control input
V _{EE}	10	negative line terminal
QR	11	earpiece amplifier output
GAR	12	earpiece amplifier gain adjustment
MIC+	13	non-inverting microphone amplifier input
MIC-	14	inverting microphone amplifier input
LEDC	15	LED control output
V _{CC}	16	supply voltage for internal circuit

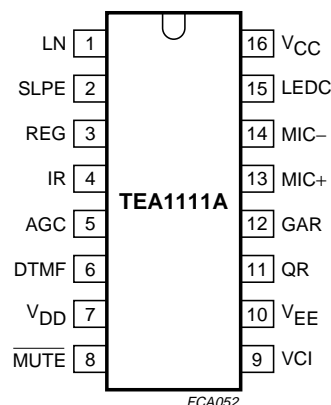


Fig.2 Pin configuration.

FUNCTIONAL DESCRIPTION

All data given in this chapter concerns typical values, except when otherwise specified.

Supply (pins LN, SLPE, REG, V_{CC} and V_{DD})

The supply for the TEA1111A and its peripherals is obtained from the telephone line (see Fig.3).

THE LINE INTERFACE (PINS LN, SLPE AND REG)

The IC generates a stabilized reference voltage (V_{ref}) across pins LN and SLPE. V_{ref} is temperature compensated and can be adjusted by using an external resistor (R_{VA}). V_{ref} equals 3.8 V and can be increased by connecting R_{VA} between pins REG and SLPE or decreased by connecting R_{VA} between pins REG and LN. The voltage at pin REG is used by the internal regulator to generate V_{ref} and is decoupled by C_{REG} , which is connected to V_{EE} . This capacitor, converted to an equivalent inductance, (see Section "Set impedance") determines the set impedance conversion from its DC value (R_{SLPE}) to its AC value (R_{CC} in the audio-frequency range). The voltage at pin SLPE is proportional to the line current.

The voltage at pin LN is:

$$V_{LN} = V_{ref} + R_{SLPE} \times I_{SLPE}$$

$$I_{SLPE} = I_{line} - I_{CC} - I_P - I_{SUP} - I_{LEDC}$$

where:

I_{line} = line current

I_{CC} = current consumption of the IC

I_P = supply current for external circuits

I_{SUP} = current consumed between LN and V_{EE} by the V_{DD} regulator

I_{LEDC} = supply current for external LED circuitry.

The preferred value for R_{SLPE} is 20 Ω . Changing R_{SLPE} will affect more than the DC characteristics; it also influences the microphone and DTMF gains, the gain control characteristics, the sidetone level and the maximum output swing on the line.

The DC line current flowing into the set is determined by the exchange supply voltage (V_{EXCH}), the feeding bridge resistance (R_{EXCH}), the DC resistance of the telephone line (R_{line}) and the reference voltage (V_{ref}). With line currents below I_{low} (9 mA), the internal reference voltage (generating V_{ref}) is automatically adjusted to a lower value.

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This means that several sets can operate in parallel with DC line voltages (excluding the polarity guard) down to an absolute minimum voltage of 1.5 V. At line currents below I_{LOW} , the circuit has limited sending and receiving levels. This is called the low voltage area.

THE INTERNAL SUPPLY POINT (PIN V_{CC})

The internal circuitry of the TEA1111A is supplied from pin V_{CC} . This voltage supply is derived from the line voltage by means of a resistor (R_{CC}) and must be decoupled by a capacitor C_{VCC} . It may also be used to supply some external circuits.

The V_{CC} voltage (see also Figs 4 and 5) depends on the current consumed by the IC and the peripheral circuits as:

$$V_{CC0} = V_{LN} - R_{CC} \times I_{CC}$$

$$V_{CC} = V_{CC0} - R_{CC} \times (I_P + I_{rec})$$

Where I_{rec} is the current consumed by the output stage of the earpiece amplifier.

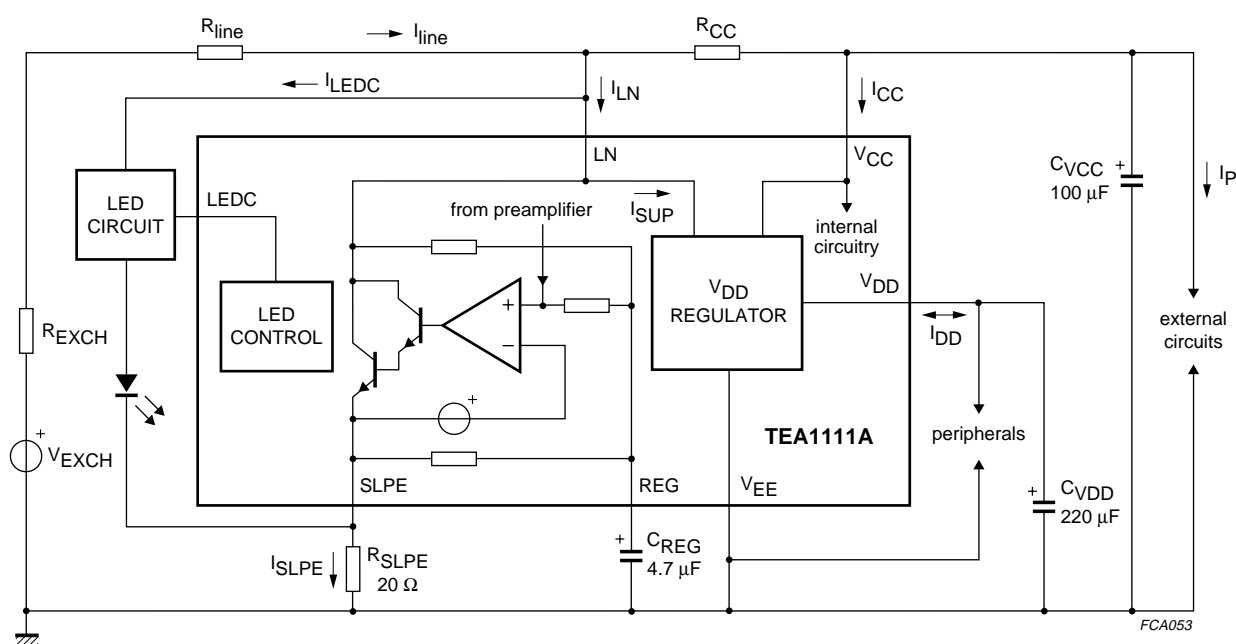


Fig.3 Supply configuration.

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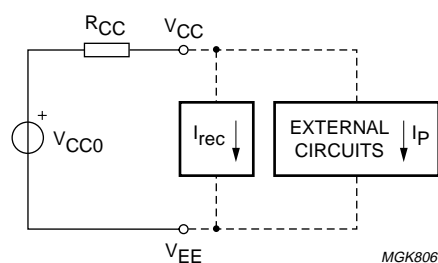
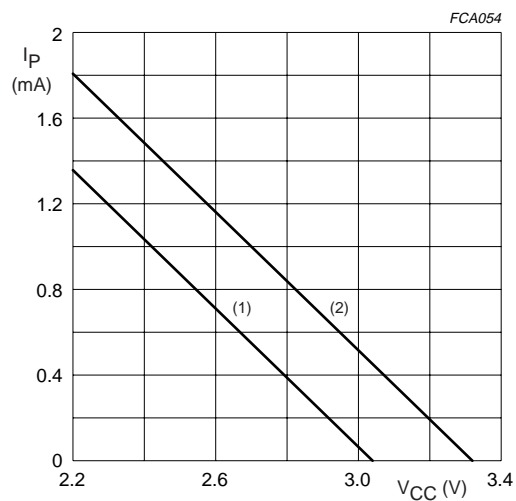


Fig.4 V_{CC} used as supply voltage for external circuits.



$V_{CC} \geq 2.2$ V; $V_{LN} = 4$ V at $I_{line} = 15$ mA; $R_{CC} = 619 \Omega$; $R_{SLPE} = 20 \Omega$.

(1) Curve 1 is valid when the earpiece amplifier is driven: $V_{QR(rms)} = 150$ mV; $R_L = 150 \Omega$.

(2) Curve 2 is valid when the earpiece amplifier is not loaded.

Fig.5 Typical current I_P available from V_{CC} for peripheral circuitry.

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THE REGULATED SUPPLY POINT (PIN V_{DD})

The V_{DD} regulator delivers a stabilized voltage for the peripherals in transmission mode (nominal V_{LN}) as well as in ringer mode ($V_{LN} = 0$ V). The regulator (see Fig.6) consists of a sense input circuit fed by pin LN, a current switch and a V_{DD} output stabilizer.

The regulator function depends on the transmission, ringer and trickle modes as follows:

- **Transmission mode:** The regulator operates as a current source at the LN input; it takes a constant current of $I_{SUP} = 4.3 \text{ mA}$ (at nominal conditions) from pin LN. The current switch reduces the distortion on the line at large signal swings. Output V_{DD} follows the DC voltage at pin LN (with typically 0.35 V difference) up to $V_{DD} = 3.25 \text{ V}$. The input current of the regulator is constant while the output (source) current is determined by the consumption of the peripherals. The difference between input and output currents is shunted by the internal V_{DD} stabilizer.

- **Ringer mode:** The regulator operates as a shunt stabilizer to keep V_{DD} at 3.3 V. The input voltage V_{LN} equals 0 V while the input current into pin V_{DD} is delivered by the ringing signal. V_{DD} has to be decoupled by a capacitor C_{VDD} .
- **Trickle mode:** When V_{DD} is below 2 V, the regulator is inhibited. The current consumption of the V_{DD} regulator in trickle mode is very low to save most of the trickle current for memory retention of a dialler.

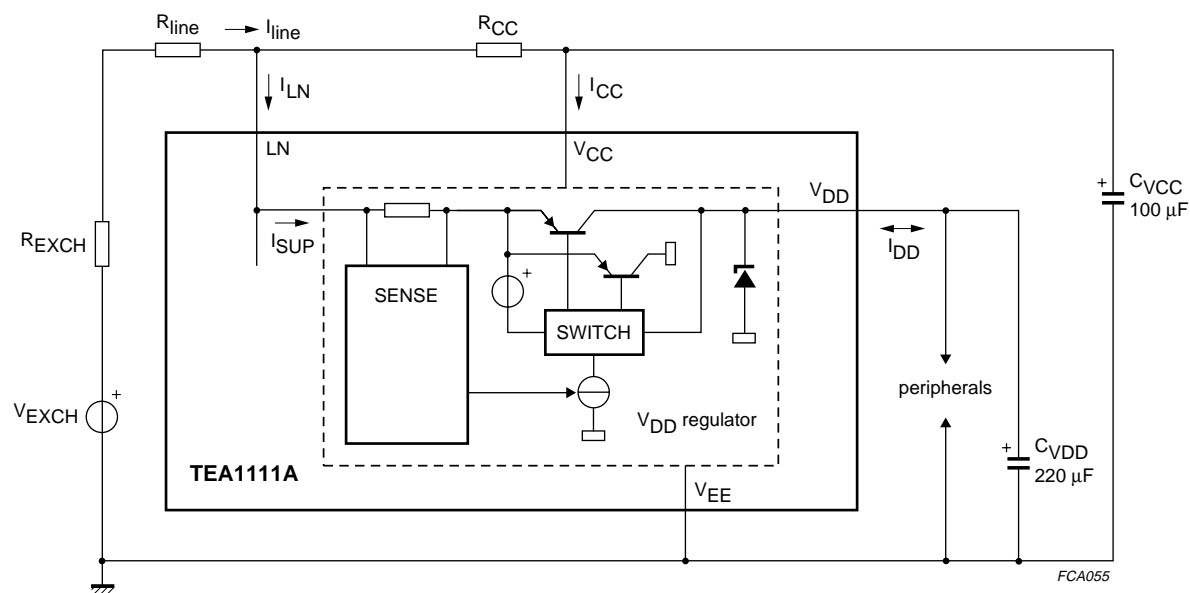


Fig.6 V_{DD} regulator configuration.

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LED control (pin LEDC)

The TEA1111A gives an on-hook/off-hook status indication. This is achieved by a current made available at pin LEDC to drive an external LED circuit connected between pins SLPE and LN (see Fig.7). In the low voltage area, which corresponds to low line current conditions, no current is available for this LED. For line currents higher than a threshold, the LEDC current increases proportionally to the line current (with a ratio of 1:150). The LEDC current is internally limited to 470 μ A (see Fig.8).

For 12 mA < I_{line} < 82 mA:
$$I_{LEDC} = \frac{I_{line} - 12}{150}$$

This LED circuit is referenced to SLPE. Consequently, all the LED supply current will flow through the R_{SLPE} resistor, and does not affect the behaviour of the AGC.

Set impedance

In the audio frequency range, the dynamic impedance is mainly determined by the R_{CC} resistor. The equivalent impedance of the circuit is illustrated in Fig.9.

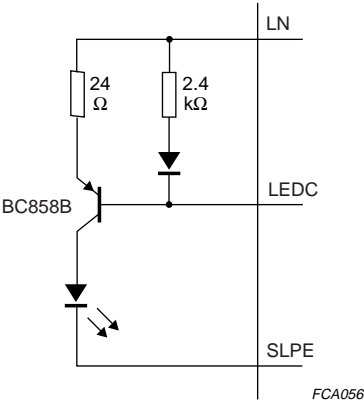


Fig.7 LED circuit configuration.

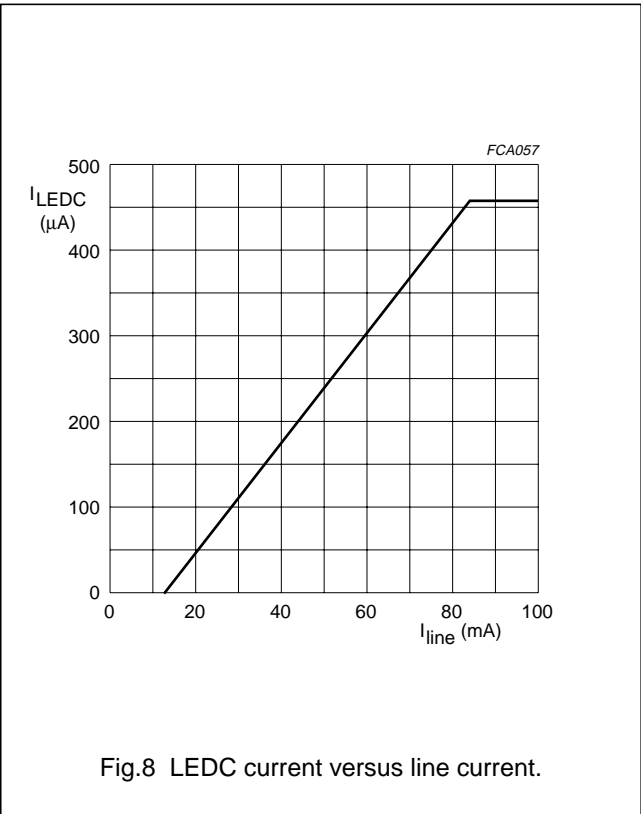
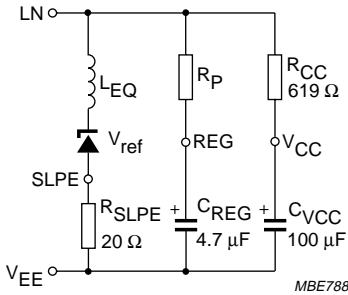


Fig.8 LEDC current versus line current.



$$L_{EQ} = C_{REG} \times R_{SLPE} \times R_P.$$

R_P = internal resistance.
R_P = 17.5 k Ω .

Fig.9 Equivalent impedance between LN and V_{EE}.

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Transmit stage (pins MIC+, MIC– and DTMF)

MICROPHONE AMPLIFIER (PINS MIC+ AND MIC–)

The TEA1111A has symmetrical microphone inputs. The input impedance between pins MIC+ and MIC– is 68 k Ω (2×34 k Ω). The voltage gain from pins MIC+/MIC– to pin LN is set at 44.2 dB (typical) at 600 Ω line load.

Automatic gain control is provided on this amplifier for line loss compensation.

DTMF AMPLIFIER (PIN DTMF)

When the DTMF amplifier is enabled, dialling tones may be sent on line. These tones are also sent to the receive output QR at a low level (confidence tone), the level is controlled by pin VCI.

The TEA1111A has an asymmetrical DTMF input. The input impedance between DTMF and V_{EE} is 20 k Ω and it is biased at V_{EE}. The voltage gain from pin DTMF to pin LN is set at 25.9 dB.

Automatic gain control has no effect on the DTMF amplifier.

Receiving stage (pins IR, GAR, QR and VCI)

The receive part consists of an earpiece amplifier and a volume control block.

EARPIECE AMPLIFIER

The earpiece amplifier has one input (IR) and one output (QR). The input impedance between pin IR and pin V_{EE} is 22 k Ω . When pin VCI is tied to V_{EE}, the voltage gain from pin IR to pin QR is set at 27.4 dB (typical) which reduces the attenuation of the receive signal by the anti-sidetone network from 32 dB to 4.6 dB. The gain can be decreased by connecting an external resistor R_{GARExt} between pins GAR and QR; the adjustment range is 6 dB. Two external capacitors C_{GAR} (connected between pins GAR and QR) and C_{GARS} (connected between pins GAR and V_{EE}) ensure stability. Capacitor C_{GAR} provides a first-order low-pass filter. The cut-off frequency corresponds to the time constant C_{GAR} \times R_{GARint}. Where R_{GARint} is the internal resistor (123 k Ω typical) which sets the gain. The relationship C_{GARS} = 10 \times C_{GAR} must be complied with to ensure stability.

The output voltage of the earpiece amplifier is specified for continuous wave drive. The maximum output swing depends on the DC line voltage, the R_{CC} resistor, the I_{CC} current consumption of the circuit, the I_P current consumption of the peripheral circuits and the load impedance.

Automatic gain control is provided on this amplifier for line loss compensation.

VOLUME CONTROL (PIN VCI)

A positive DC voltage applied to pin VCI allows the gain of the earpiece amplifier to be increased in steps of 4.85 dB. The volume control range is 27.4 to 41.9 dB (14.5 dB typical). A proportional voltage decoder at pin VCI defines a gain of 27.4 dB when V_{VCI} equals V_{EE} and a gain of 41.9 dB when V_{VCI} equals V_{DD}.

The intermediate steps correspond to: $V_{VCI} = \frac{1}{3}V_{DD}$

and $V_{VCI} = \frac{2}{3}V_{DD}$.

Automatic gain control (pin AGC)

The TEA1111A performs automatic line loss compensation. The automatic gain control varies the gain of the microphone amplifier and the gain of the receive amplifier in accordance with the DC line current.

The control range is 6.0 dB (which corresponds approximately to a line length of 5 km for a 0.5 mm diameter twisted-pair copper cable with a DC resistance of 176 Ω /km and an average attenuation of 1.2 dB/km).

The IC can be used with different configurations of feeding bridge (supply voltage and bridge resistance) by connecting an external resistor R_{AGC} between pins AGC and V_{EE}. This resistor enables the I_{start} and I_{stop} line currents to be increased (the ratio between I_{start} and I_{stop} is not affected by the resistor). The AGC function is disabled when pin AGC is left open circuit.

Mute function (pin MUTE)

The mute function performs the switching between the speech mode and the dialling mode.

When $\overline{\text{MUTE}}$ is LOW, the DTMF input is enabled and the microphone and receive amplifier inputs are disabled. In this mode, the DTMF tones are sent to the receive output at a low level (confidence tone).

When $\overline{\text{MUTE}}$ is HIGH, the microphone and receiving amplifiers inputs are enabled while the DTMF input is disabled. The MUTE input is provided with an internal pull-up current source to V_{DD}.

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Sidetone suppression

The TEA1111A anti-sidetone network comprising $R_{CC} // Z_{line}$, R_{ast1} , R_{ast2} , R_{ast3} , R_{SLPE} and Z_{bal} (see Fig.10) suppresses the transmitted signal in the earpiece.

Maximum compensation is obtained when the following conditions are fulfilled:

$$R_{SLPE} \times R_{ast1} = R_{CC} \times (R_{ast2} + R_{ast3})$$

$$k = \frac{R_{ast2} \times (R_{ast3} + R_{SLPE})}{R_{ast1} \times R_{SLPE}}$$

$$Z_{bal} = k \times Z_{line}$$

The scale factor k is chosen to meet the compatibility with a standard capacitor from the E6 or E12 range for Z_{bal} .

In practice, Z_{line} varies considerably with the line type and the line length. Therefore, the value of Z_{bal} should be for an average line length, which gives satisfactory sidetone suppression with short and long lines. The suppression also depends on the accuracy of the match between Z_{bal} and the impedance of the average line.

The anti-sidetone network for the TEA1111A attenuates the receive signal from the line by 32 dB before it enters the receive stage. The attenuation is almost constant over the whole audio frequency range.

A Wheatstone bridge configuration (see Fig.11) may also be used.

More information on the balancing of an anti-sidetone bridge can be obtained in our publication "Semiconductors for Wired Telecom Systems; Applications Handbook IC03b".

For ordering information, please contact the Philips Semiconductors sales office.

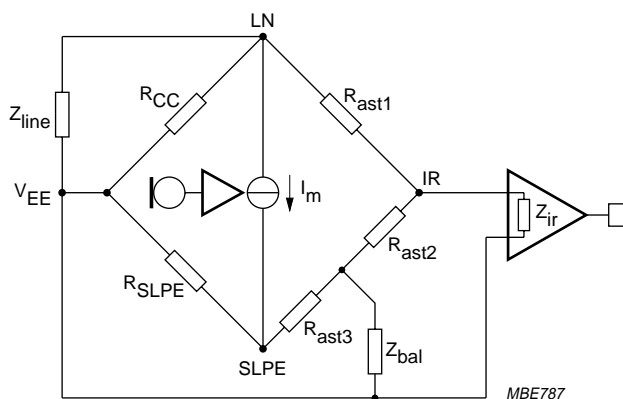


Fig.10 Equivalent circuit of TEA1111A anti-sidetone bridge.

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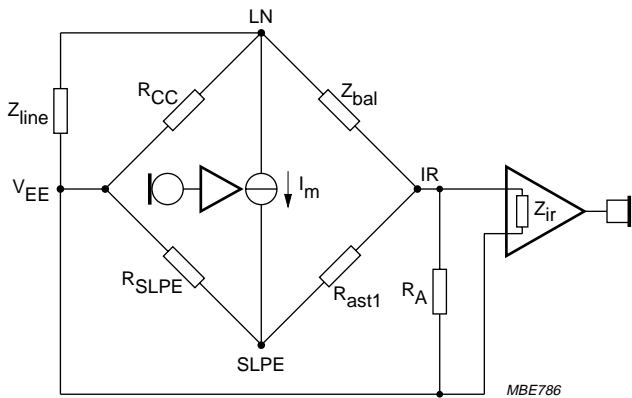


Fig.11 Equivalent circuit of an anti-sidetone network in a Wheatstone bridge configuration.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{LN}	positive continuous line voltage		V _{EE} – 0.4	12	V
	repetitive line voltage during switch-on or line interruption		V _{EE} – 0.4	13.2	V
I _{DD}	maximum input current at pin V _{DD}		–	75	mA
V _{CC}	supply voltage		V _{EE} – 0.4	12	V
V _{MUTE} , V _{VCI}	maximum voltage on pins MUTE and VCI		V _{EE} – 0.4	V _{DD} + 0.4	V
V _{n(max)}	maximum voltage on all pins except pins V _{DD} , MUTE and VCI		V _{EE} – 0.4	V _{CC} + 0.4	V
I _{line}	line current	R _{SLPE} = 20 Ω; see Fig.12	–	140	mA
P _{tot}	TEA1111AT total power dissipation	T _{amb} = 75 °C; see Fig.12	–	416	mW
T _{stg}	storage temperature		–40	+125	°C
T _{amb}	ambient temperature		–25	+75	°C
T _j	junction temperature		–	+125	°C

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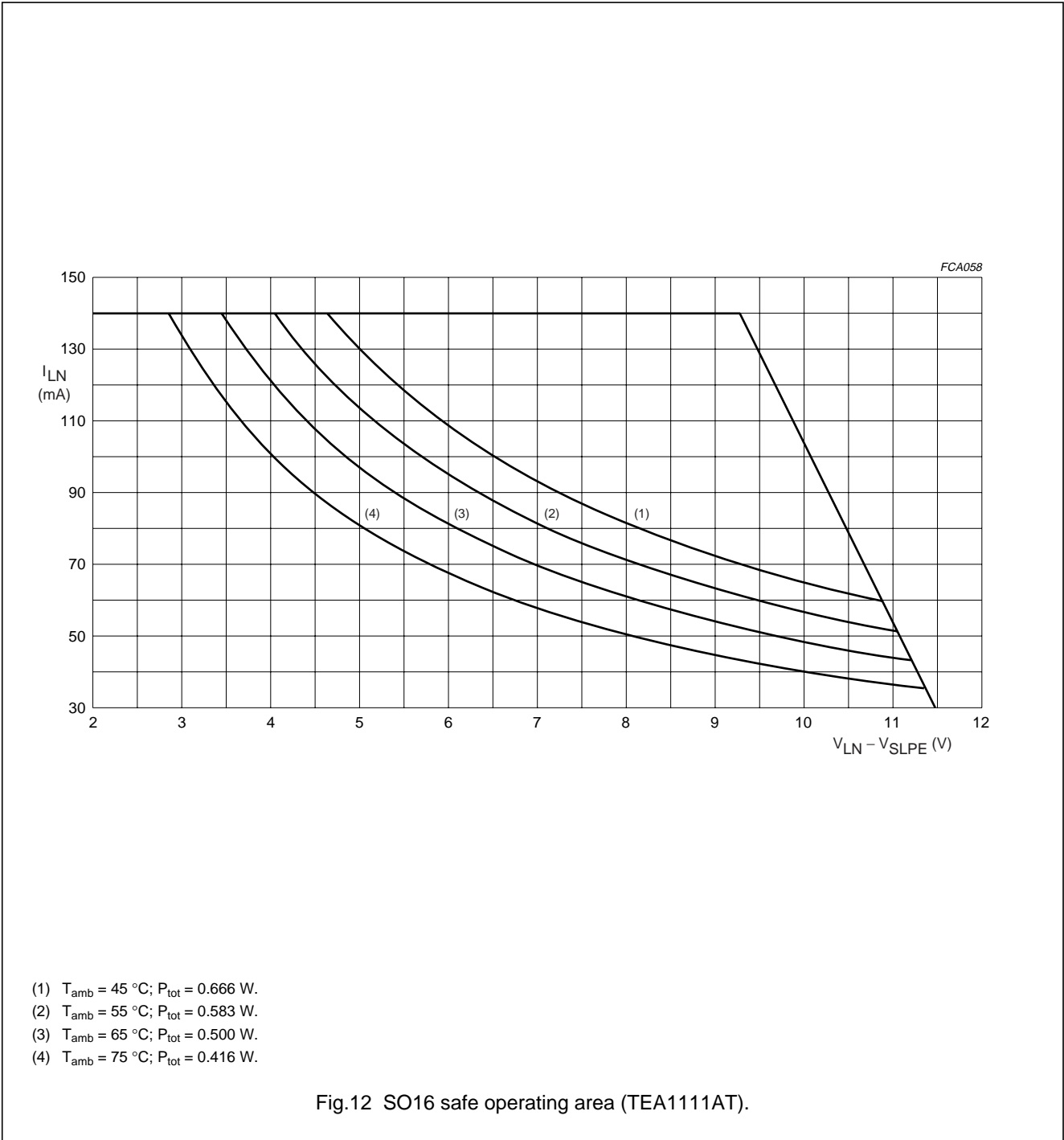
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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; note 1	110	K/W

Note

1. Mounted on epoxy board 40.1 × 19.1 × 1.5 mm.



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CHARACTERISTICS

$I_{line} = 15 \text{ mA}$; $V_{EE} = 0 \text{ V}$; $V_{VCI} = 0 \text{ V}$; $R_{SLPE} = 20 \text{ }\Omega$; pin AGC connected to V_{EE} ; $Z_{line} = 600 \text{ }\Omega$; $f = 1 \text{ kHz}$; measured according to test circuits given in Figs 14, 15 and 16; $T_{amb} = 25 \text{ }^{\circ}\text{C}$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply (pins LN, V_{CC}, SLPE, REG and V_{DD})						
THE LINE INTERFACE (PINS LN, SLPE AND REG)						
V_{ref}	stabilized reference voltage between pins LN and SLPE		3.5	3.8	4.1	V
V_{LN}	DC line voltage	$I_{line} = 1 \text{ mA}$	–	1.5	–	V
		$I_{line} = 4 \text{ mA}$	–	2.5	–	V
		$I_{line} = 15 \text{ mA}$	3.7	4.0	4.3	V
		$I_{line} = 140 \text{ mA}$	–	6.7	7.2	V
$V_{LN(Rext)}$	DC line voltage with an external resistor R_{VA}	$R_{VA} = 90 \text{ k}\Omega$ (between pins LN and REG)	–	3.6	–	V
$\Delta V_{LN(T)}$	DC line voltage variation with temperature referenced to $25 \text{ }^{\circ}\text{C}$	$T_{amb} = -25 \text{ to } +75 \text{ }^{\circ}\text{C}$	–	± 40	–	mV
THE INTERNAL SUPPLY POINT (PIN V_{CC})						
I_{CC}	internal current consumption	$V_{CC} = 3.3 \text{ V}$	–	1.15	1.4	mA
V_{CC}	supply voltage for internal circuitry	$I_P = 0 \text{ mA}$	–	3.3	–	V
THE REGULATED SUPPLY POINT (PIN V_{DD})						
I_{SUP}	input current of the V_{DD} regulator (current from pin LN not flowing through pin SLPE)	$I_{line} = 1 \text{ mA}$	–	0	–	mA
		$I_{line} = 4 \text{ mA}$	–	1.2	–	mA
		$I_{line} \geq 11 \text{ mA}$	–	4.3	–	mA
V_{DD}	regulated supply voltage in: speech mode	$I_{DD} = -3 \text{ mA}$; $V_{LN} > 3.6 \text{ V} + 0.28 \text{ V (typ.)}$; $I_{line} \geq 11 \text{ mA}$	2.95	3.25	3.55	V
	speech mode at reduced performance	$I_{line} = 4 \text{ mA}$	–	$V_{LN} - 0.35$	–	V
	ringer mode	$I_{line} = 0 \text{ mA}$; $I_{DD} = 75 \text{ mA}$	3.0	3.3	3.6	V
I_{DD}	regulated supply current available in:					
	speech mode	$I_{line} \geq 11 \text{ mA}$	–	–	–3	mA
	speech mode at reduced performance	$I_{line} = 4 \text{ mA}$	–	–1	–	mA
	trickle mode	$I_{line} = 0 \text{ mA}$; V_{CC} discharging; $V_{DD} = 1.2 \text{ V}$	–	–	100	nA

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
LED control (pin LEDC)						
$I_{\text{line(h)}}$	highest line current for $I_{\text{LEDC}} < 5 \mu\text{A}$		–	13	–	mA
$I_{\text{line(l)}}$	lowest line current for maximum I_{LEDC}		–	82	–	mA
$I_{\text{LEDC(max)}}$	maximum available output current from pin LEDC		–	470	–	μA
Transmit stage (pins MIC+, MIC– and DTMF)						
MICROPHONE AMPLIFIER (PINS MIC+ AND MIC–)						
$ Z_i $	input impedance differential between pins MIC+ and MIC– single-ended between pins MIC+/MIC– and V_{EE}		– –	68 34	– –	k Ω k Ω
$G_{\text{V(TX)}}$	voltage gain from pins MIC+/MIC– to pin LN	$V_{\text{MIC}} = 4 \text{ mV (RMS)}$	43.2	44.2	45.2	dB
$\Delta G_{\text{V(TX)(f)}}$	voltage gain variation with frequency referenced to 1 kHz	$f = 300 \text{ to } 3400 \text{ Hz}$	–	± 0.2	–	dB
$\Delta G_{\text{V(TX)(T)}}$	voltage gain variation with temperature referenced to 25 °C	$T_{\text{amb}} = -25 \text{ to } +75 \text{ °C}$	–	± 0.3	–	dB
CMRR	common mode rejection ratio		–	80	–	dB
$V_{\text{LN(max)(rms)}}$	maximum sending signal (RMS value)	$I_{\text{line}} = 15 \text{ mA}; \text{THD} = 2\%$ $I_{\text{line}} = 4 \text{ mA}; \text{THD} = 10\%$	1.8 –	2 0.45	– –	V V
$V_{\text{no(LN)}}$	noise output voltage at pin LN	psophometrically weighted (P53 curve); pins MIC+/MIC– short circuited through 200 Ω	–	–77	–	dBmp
DTMF AMPLIFIER (PIN DTMF)						
$ Z_i $	input impedance		–	20	–	k Ω
$G_{\text{V(DTMF)}}$	voltage gain from pin DTMF to pin LN	$V_{\text{DTMF}} = 20 \text{ mV (RMS)};$ $\text{MUTE} = \text{LOW}$	24.9	25.9	26.9	dB
$\Delta G_{\text{V(DTMF)(f)}}$	voltage gain variation with frequency referenced to 1 kHz	$f = 300 \text{ to } 3400 \text{ Hz}$	–	± 0.2	–	dB
$\Delta G_{\text{V(DTMF)(T)}}$	voltage gain variation with temperature referenced to 25 °C	$T_{\text{amb}} = -25 \text{ to } +75 \text{ °C}$	–	± 0.4	–	dB
$G_{\text{V(ct)}}$	voltage gain from pin DTMF to pin QR (confidence tone)	$V_{\text{DTMF}} = 20 \text{ mV (RMS)};$ $R_L = 150 \Omega;$ $\text{MUTE} = \text{LOW}; V_{\text{VCI}} = 0 \text{ V}$	–	–15.6	–	dB

Speech circuit with dialler interface, regulated supply and earpiece volume control

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Receive stage (pins IR, GAR, QR and VCI)						
THE EARPIECE AMPLIFIER (PINS IR AND QR)						
Z _i	input impedance		–	22	–	kΩ
G _{V(QR)}	voltage gain from pin IR to pin QR	V _{IR} = 4 mV (RMS); V _{VCI} = 0 V	26.4	27.4	28.4	dB
ΔG _{V(QR)(f)}	voltage gain variation with frequency referenced to 1 kHz	f = 300 to 3400 Hz	–	±0.2	–	dB
ΔG _{V(QR)(T)}	voltage gain variation with temperature referenced to 25 °C	T _{amb} = –25 to +75 °C	–	±0.3	–	dB
ΔG _{V(QR)}	voltage gain reduction range	external resistor connected between pins GAR and QR	–	–	6	dB
V _{QR(max)(rms)}	maximum receiving signal on pin QR (RMS value)	I _P = 0 mA; sine wave drive; R _L = 150 Ω; THD = 2%; V _{VCI} = V _{DD}	0.5	0.6	–	V
		I _P = 0 mA; sine wave drive; R _L = 450 Ω; THD = 2%; V _{VCI} = V _{DD}	0.8	0.9	–	V
V _{no(QR)(rms)}	noise output voltage at pin QR (RMS value)	IR open circuit; R _L = 150 Ω; V _{VCI} = 0 V; psophometrically weighted (P53 curve)	–	–90	–	dBVp
		V _{VCI} = V _{DD}	–	–75	–	dBVp
VOLUME CONTROL (PIN VCI)						
ΔG _{V(QR)max}	maximum increase in voltage gain	V _{IR} = 4 mV (RMS); V _{VCI} = V _{DD}	12	14.5	17	dB
ΔG _{V(QR)step}	step voltage gain	V _{IR} = 4 mV (RMS)	3.85	4.85	5.85	dB
Automatic gain control (pin AGC)						
ΔG _{V(trx)}	voltage gain control range for microphone and earpiece amplifiers w.r.t. I _{line} = 15 mA	I _{line} = 85 mA	–	6.0	–	dB
I _{start}	highest line current for maximum gain		–	23	–	mA
I _{stop}	lowest line current for min. gain		–	59	–	mA
Mute function (pin MUTE)						
V _{IL}	LOW-level input voltage		V _{EE} – 0.4	–	V _{EE} + 0.3	V
V _{IH}	HIGH-level input voltage		V _{EE} + 1.5	–	V _{DD} + 0.4	V
I _{MUTE}	input current		–10	–2	–	μA
ΔG _{V(trx)(m)}	voltage gain reduction for: microphone amplifier earpiece amplifier DTMF amplifier	MUTE = LOW	–	80	–	dB
		MUTE = LOW	–	80	–	dB
		MUTE = HIGH	–	80	–	dB

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TEST AND APPLICATION INFORMATION

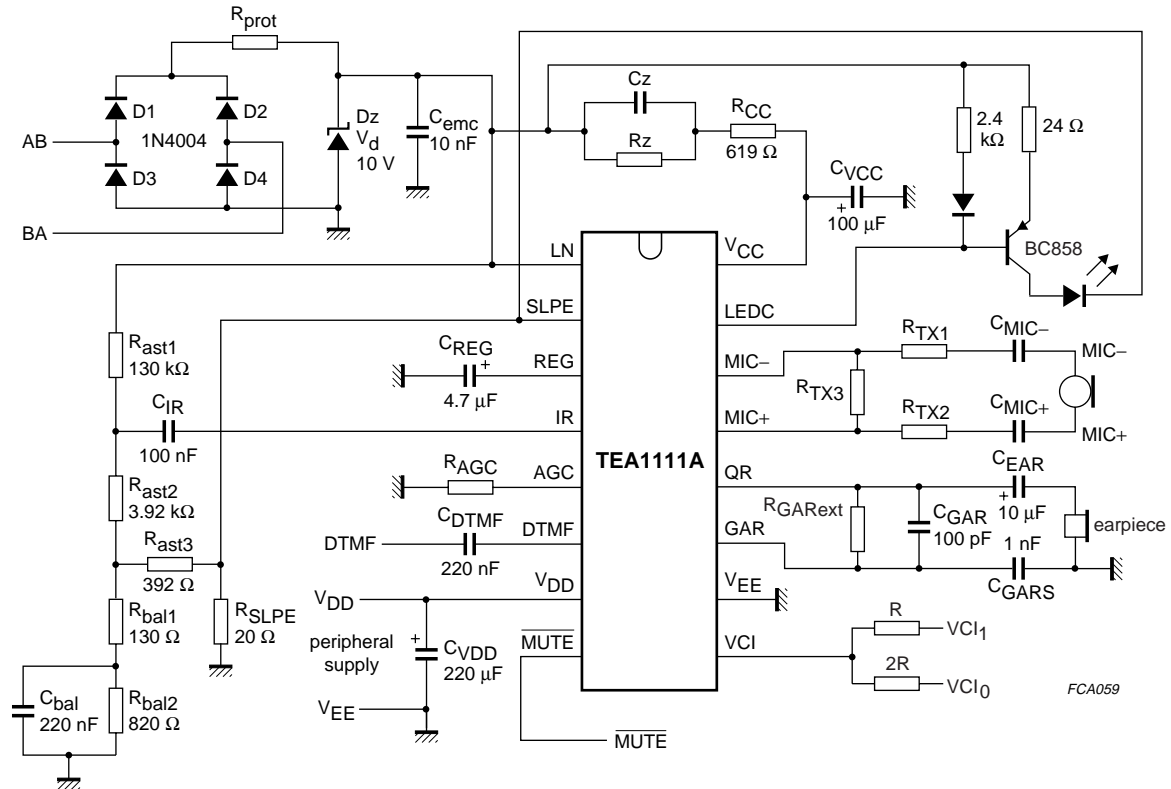
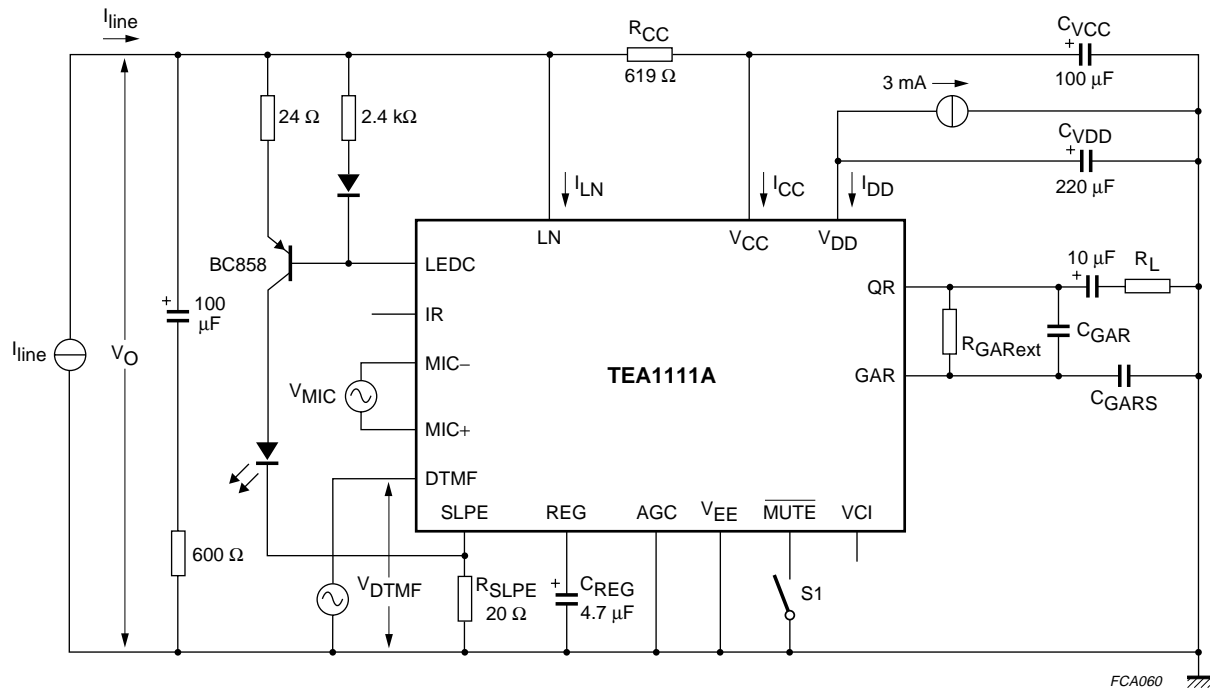


Fig.13 Basic application diagram.

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Voltage gain defined as $G_v = 20 \log \left| \frac{V_o}{V_i} \right|$; $V_i = V_{MIC}$ or V_{DTMF} .

Microphone gain: S1 = open.

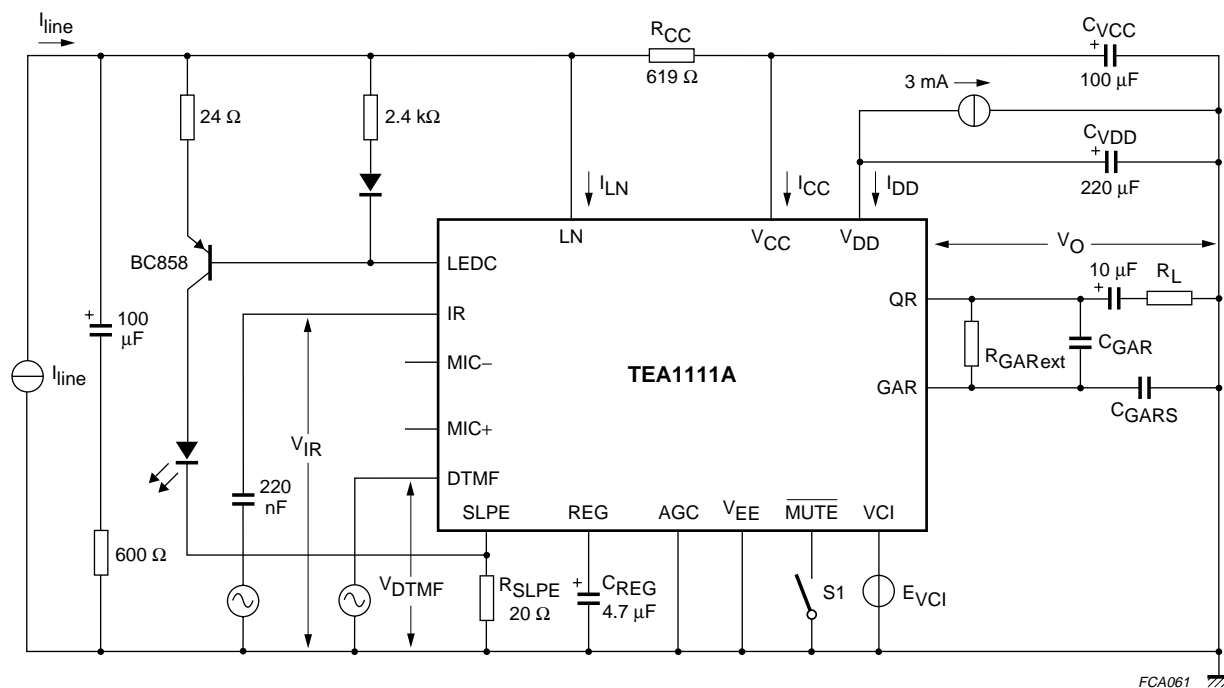
DTMF gain: S1 = closed.

Inputs not being tested should be open circuit.

Fig.14 Test circuit for defining transmit gains.

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Voltage gain defined as $G_v = 20 \log \left| \frac{V_o}{V_i} \right|$; $V_i = V_{IR}$ or V_{DTMF} .
 Earpiece gain: $S1 = \text{open}$

Earpiece gain: S1 = open.

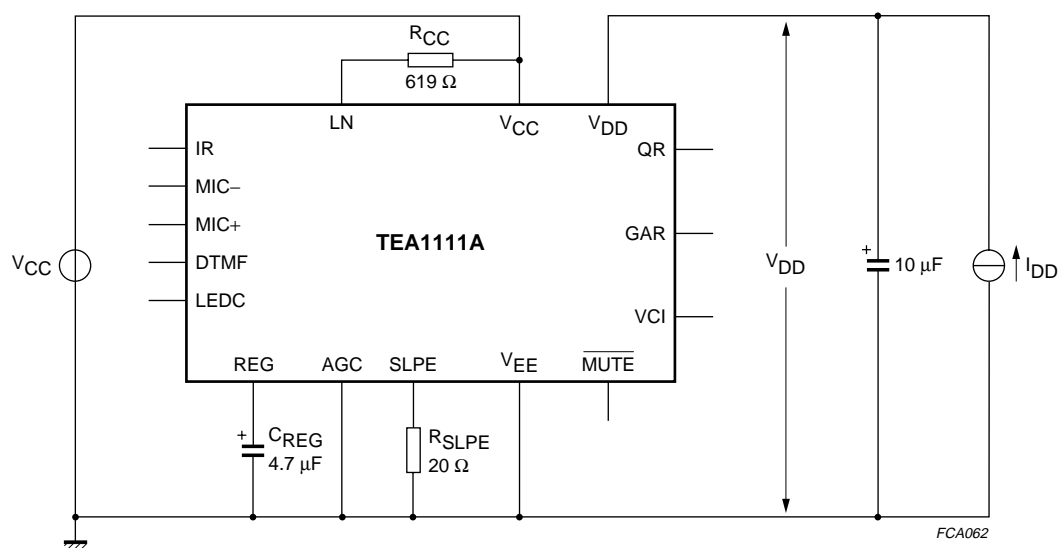
Confidence tone: S1 = closed.

Inputs not being tested should be open circuit.

Fig.15 Test circuit for defining earpiece gains.

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Inputs not being tested should be open circuit.

Fig.16 Test circuit for defining regulated supply (V_{DD}) performance in ringer and trickle modes.

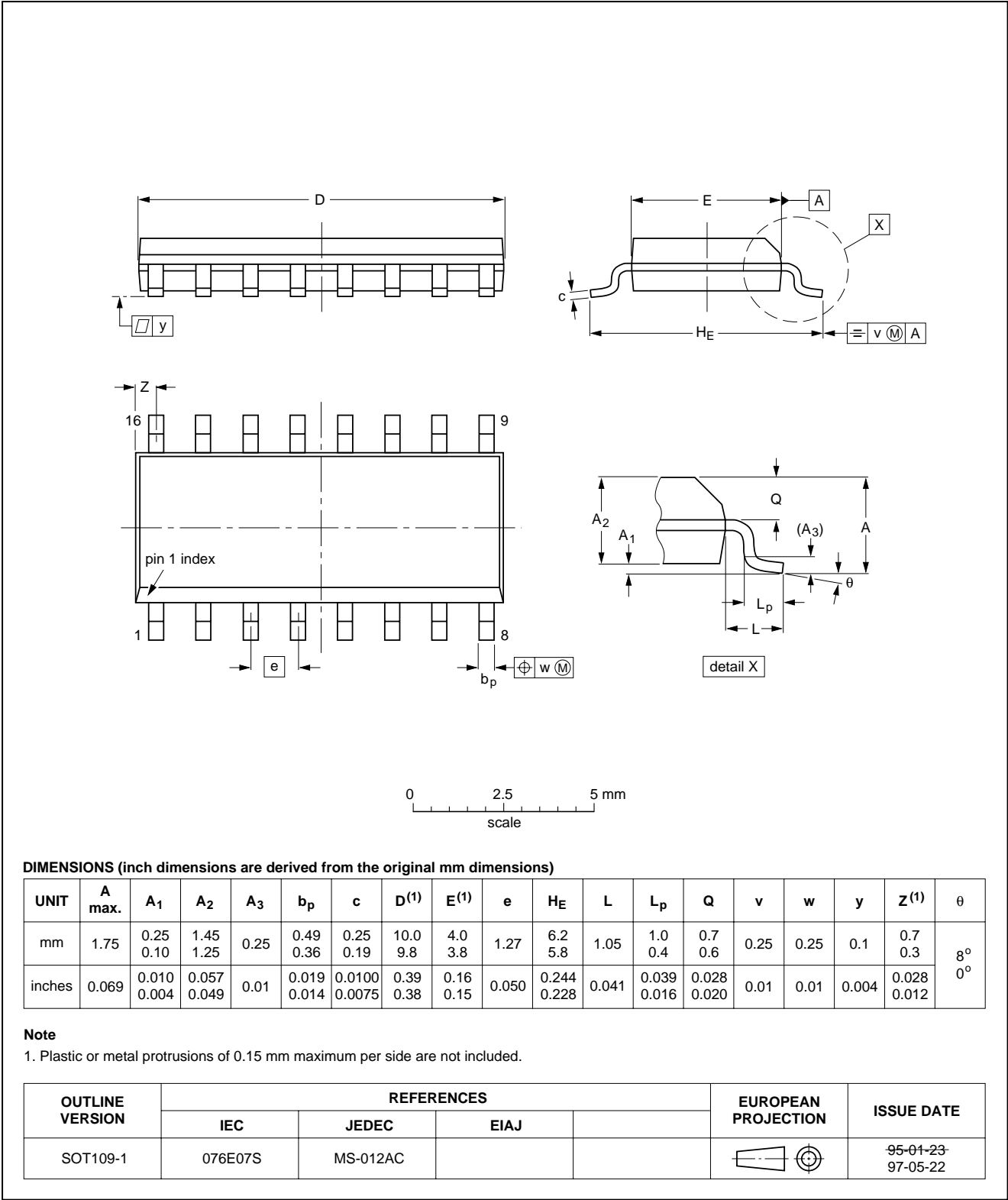
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PACKAGE OUTLINE

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



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SOLDERING

Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferably be kept below 230 °C.

Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is **preferred** to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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Suitability of surface mount IC packages for wave and reflow soldering methods

PACKAGE	SOLDERING METHOD	
	WAVE	REFLOW ⁽¹⁾
BGA, SQFP	not suitable	suitable
HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, SMS	not suitable ⁽²⁾	suitable
PLCC ⁽³⁾ , SO, SOJ	suitable	suitable
LQFP, QFP, TQFP	not recommended ⁽³⁾⁽⁴⁾	suitable
SSOP, TSSOP, VSO	not recommended ⁽⁵⁾	suitable

Notes

1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the *"Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods"*.
2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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